



PCB Number: PMP9649  
PCB Rev: A

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Designed for: Public Release		Mod. Date: 7/1/2014	
Project Title: UCC28720 High-side Buck Converter		Number: PMP9649	
Sheet Title: 85Vac: 265Vac to 20V/0.3A		Rev: A	
Assembly Variant: [No Variations]		SVN Rev: Not in version control	
File: PMP9649_01.SchDoc		Sheet: 1 of 2	
Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>		Engineer: Enter name of project lead	
Size: B		http://www.ti.com	
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